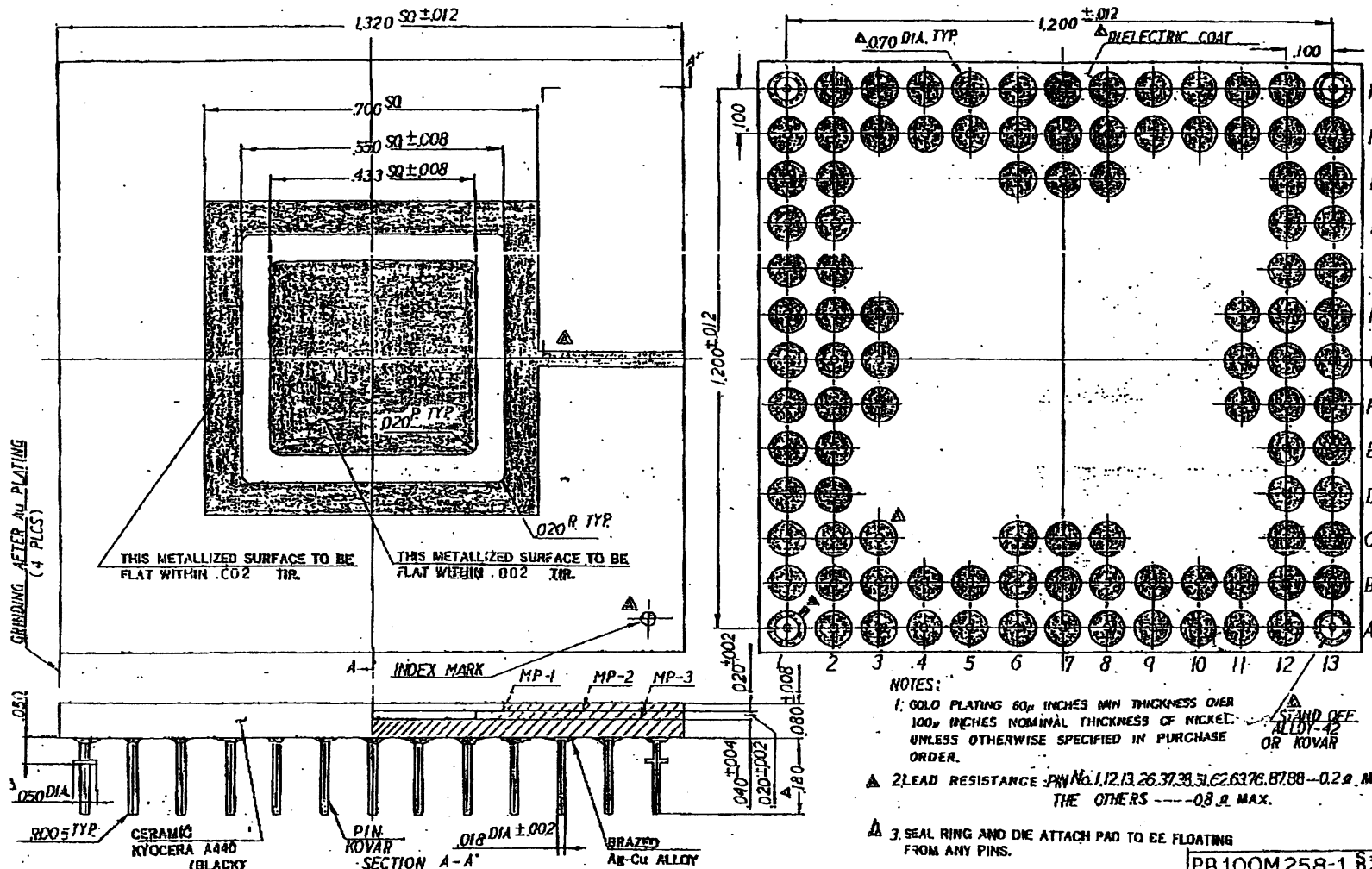


SSM P/N CPG10017

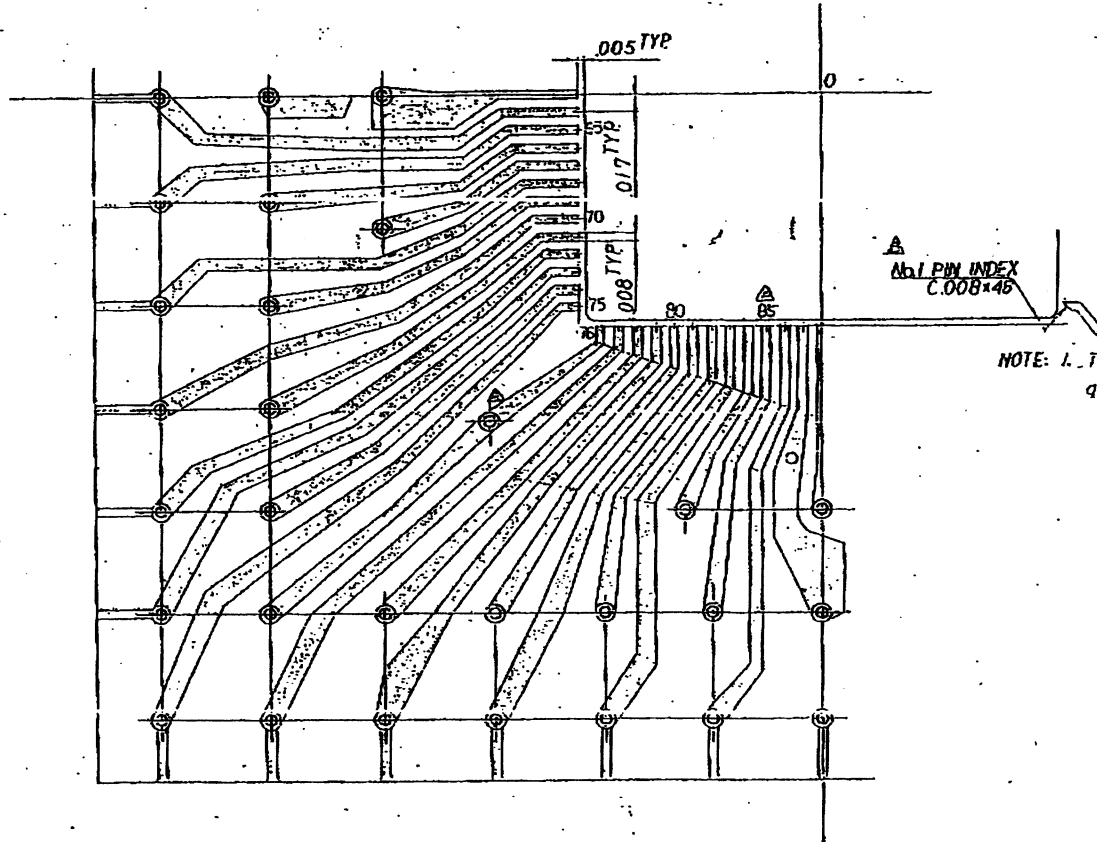


NOTES:
 1. GOLD PLATING 60μ INCHES MIN THICKNESS OVER 100μ INCHES NOMINAL THICKNESS OF NICKEL UNLESS OTHERWISE SPECIFIED IN PURCHASE ORDER.
 2. LEAD RESISTANCE: PIN No. 1, 12, 13, 26, 37, 39, 51, 62, 63, 76, 87, 88 --- 0.2 Ω MAX. THE OTHERS --- 0.8 Ω MAX.
 3. SEAL RING AND DIE ATTACH PAD TO BE FLOATING FROM ANY PINS.

ADDED: NOTES .3	MAY 3 '88	E. K. H. Ryo	NAME	100 PIN PLUG-IN PACKAGE	TOLERANCES	UNLESS OTHERWISE SPECIFIED	DRAWN	CHECKED
ADDED: DIELECTRIC COAT			SCALE	5 : 1	MATERIAL	AS INDICATED	APPROVED	DATE
CHANGED: STAND OFF 170-180, PAD DIA 0.80 --- 0.70	MAY 3 '88	R. O. B. S.				± 10% N.L.T. ± .005		APR 3 '88
ACTUAL	MAY 11 '88	Ryo	KYOTO CERAMIC CO LTD		KYOTO	BWC NO.	KN-R2258-D	



SSM P/N CPG10017



NOTE: 1. THIS PATTERN SHOWS 1/4 OF THE TOTAL AND IS 90° SYMMETRICAL TO THE ORIGIN.

MP-2

REVISIONS	A	ADDED: No. 1 PIN INDEX	DATE: 11/28/82	BY: [Signature]	NAME	TOLERANCES	DRAWN	CHECKED
		CHANGED: SOND PAD No.			100 PIN PLUG-IN PACKAGE	CALLS OUTLINE SPECIFIED	[Signature]	[Signature]
	A	ADDED: THROUGH HOLE			SCALE		APPROVED	DATE
					10:1			APR 3 '83
					177 KYOTO CERAMIC CO. LTD.	KYOTO JAPAN	DWG. NO.	KD-82258-D



